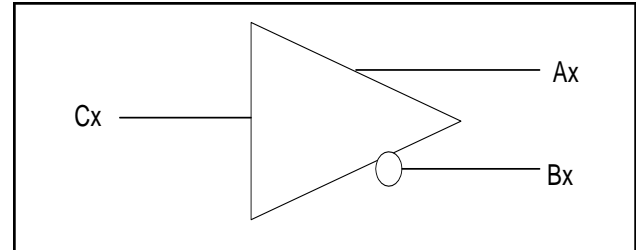


### Features

- High Speed CMOS Technology
- Complementary Outputs
- Positive Voltage Control
- Low Power Dissipation
- Plastic SOIC Package for SMT Applications
- Tape and Reel Packaging Available
- Lead-Free SOIC-16 Package
- 100% Matte Tin Plating over Copper
- Halogen-Free “Green” Mold Compound
- 260°C Reflow Compatible
- RoHS\* Compliant Version of DR65-0001

### Logic Diagram



### Description

M/A-COM's MADRCC0004 is a Quad channel driver used to translate TTL control inputs into gate voltages for GaAs FET microwave switches and attenuators. High speed analog CMOS technology is utilized to achieve low power dissipation at moderate to high speeds, encompassing most microwave switching applications.

### Ordering Information

Part Number	Package
MADRCC0004	Bulk Packaging
MADRCC0004TR	1000 piece reel

Note: Reference Application Note M513 for reel size information.

### Pin Configuration

Pin No.	Function	Pin No.	Function
1	A3	9	C2
2	B3	10	C1
3	A4	11	GND
4	B4	12	GND
5	V <sub>EE</sub>	13	A1
6	V <sub>CC</sub>	14	B1
7	C4	15	A2
8	C3	16	B2

### Guaranteed Operating Ranges

Symbol	Parameter <sup>1</sup>	Unit	Min	Typical	Max
V <sub>CC</sub>	Positive DC Supply Voltage	V	4.5	5.0	5.5
V <sub>EE</sub>	Negative DC Supply Voltage	V	-5.5	-5.0	-4.5
T <sub>A</sub>	Operating Ambient Temperature	°C	-40	+25	+85
I <sub>OH</sub>	DC Output Current - HIGH	mA	—	—	-1.0
I <sub>OL</sub>	DC Output Current - LOW	mA	—	—	1.0
T <sub>rise</sub> , T <sub>fall</sub>	Maximum Input Rise or Fall Time	nS	—	—	500

1. All voltages are relative to GND.

\* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

1

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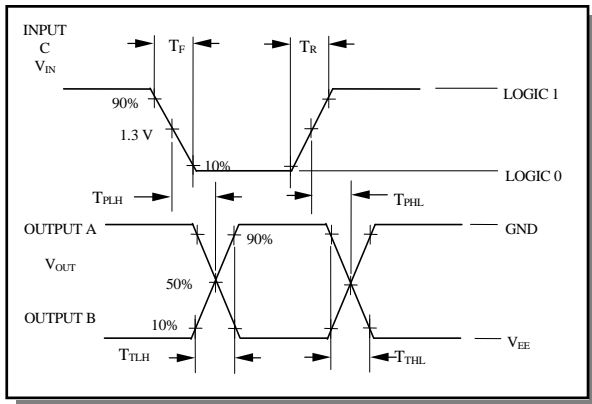
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### AC & DC Characteristics Over Guaranteed Operating Range

Symbol	Parameter	Test Conditions	Units	Min	Typ	Max
$V_{IH}$	Input HIGH Voltage	Guaranteed HIGH Input Voltage	V	2.0	—	-
$V_{IL}$	Input LOW Voltage	Guaranteed LOW Input Voltage	V	-	—	0.8
$V_{OH}$	Output HIGH Voltage	$I_{OH} = -1 \text{ mA}$ $V_{EE} = \text{Max}$	V	-0.1	—	-
$V_{OL}$	Output LOW Voltage	$I_{OL} = 1 \text{ mA}$ $V_{EE} = \text{Max}$	V	—	—	$V_{EE} + 0.1$
$I_{IN}$	Input Current	$V_{IN} = V_{CC}$ or GND $V_{EE} = \text{Min}$	$\mu\text{A}$	-10	0	10
$I_{CC}$	Quiescent Supply Current	$V_{CC} = \text{Max}$ $V_{EE} = \text{Min}$ $V_{IN} = V_{CC}$ or GND	$\mu\text{A}$	—	—	400
$\Delta I_{CC}$	Additional Supply Current, per TTL Input pin	$V_{CC} = \text{Max}$ $V_{IN} = V_{CC} - 2.1\text{V}$	mA	—	—	1.0
$T_{PHL}, T_{PLH}$	Propagation Delay	Guaranteed $-40^\circ\text{C}$ to $+85^\circ\text{C}$	nS	—	—	50
$T_{THL}, T_{TLH}$	Output Transition Time	Guaranteed $-40^\circ\text{C}$ to $+85^\circ\text{C}$	nS	—	—	25
	Delay Skew, Output A to Output B	Guaranteed $-40^\circ\text{C}$ to $+85^\circ\text{C}$	nS	—	—	8

### Switching Waveforms



Note: See Switching Wave Forms for the definition of the switching terms. Supplies must be by-passed with .01  $\mu\text{F}$  Capacitors.

Note: Unused inputs must be tied to Ground

### Handling Procedures

Please observe the following precautions to avoid damage:

### Static Sensitivity

Silicon Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

### Absolute Maximum Ratings<sup>2,3</sup>

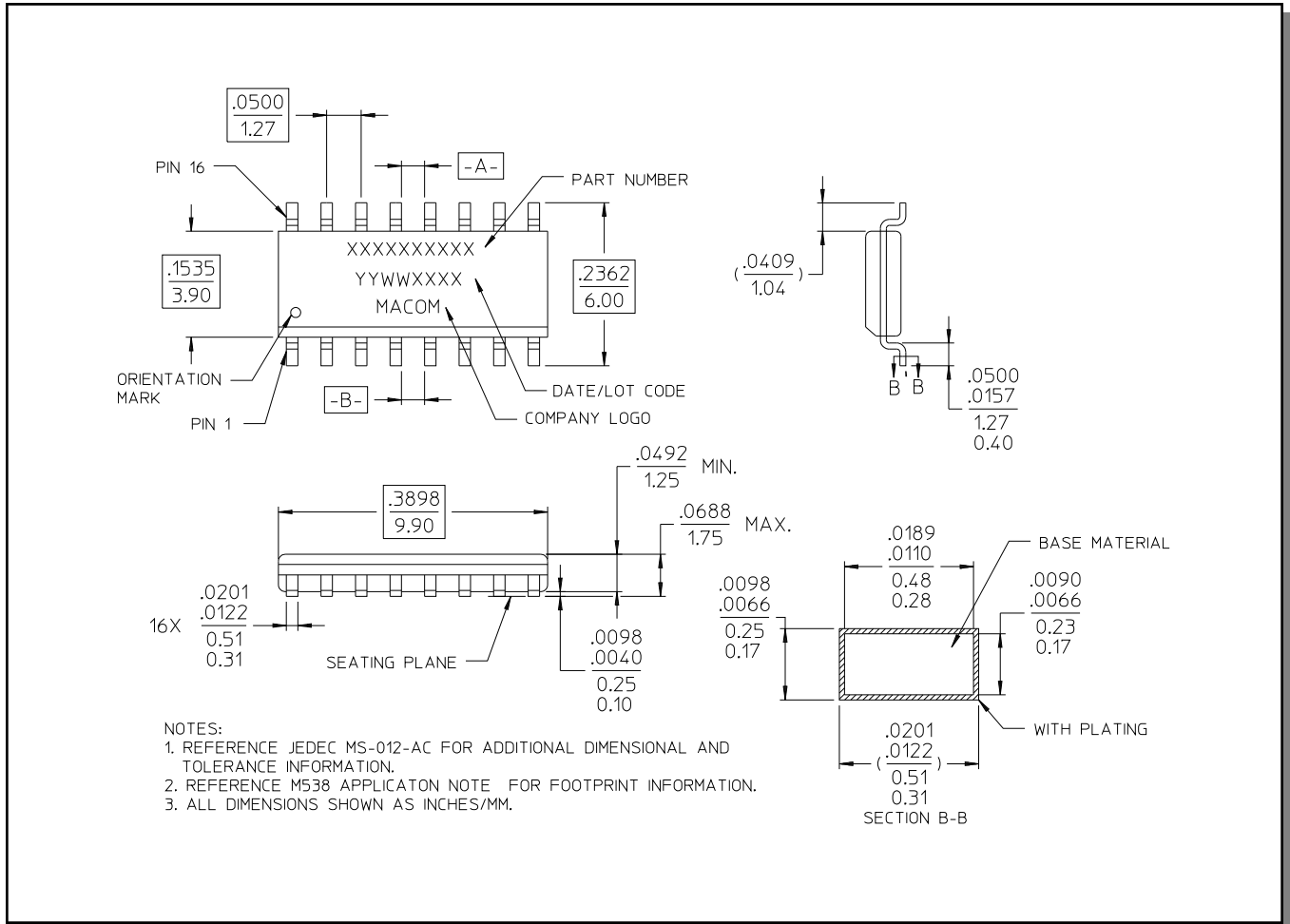
Parameter	Absolute Maximum
$V_{CC}$	- .5V to + 6.0 V
$V_{EE}$	- 6.0 V to - .5 V
$V_{CC} - V_{EE}$	12 V
$V_{IN}^4$	$V_{CC} + .5 \text{ V}$
$V_{OUT}$	$V_{EE} - .5 \text{ V}$
Storage Temperature	$-65^\circ\text{C}$ to $+150^\circ\text{C}$
Operating Temperature	$-40^\circ\text{C}$ to $+85^\circ\text{C}$

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM does not recommend sustained operation near these survivability limits.
- Standard CMOS TTL interface, latch-up will occur if logic signal is applied prior to power supply.

### Truth Table

Input	Outputs	
$C_X$	$A_X$	$B_X$
0	$V_{EE}$	GND
1	GND	$V_{EE}$

### Lead-Free, SOIC-16<sup>†</sup>



<sup>†</sup> Reference Application Note M538 for lead-free solder reflow recommendations.